

L Number	Hits	Search Text	DB	Time stamp
1	159252	(USUI or HIDEKI or IGARASHI or SAKAMOTO).in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 13:43
2	215	((USUI or HIDEKI or IGARASHI or SAKAMOTO).in.) and plasma same irradiat\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 13:43
3	74	((((USUI or HIDEKI or IGARASHI or SAKAMOTO).in.) and plasma same irradiat\$3) and (resin or polymer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 13:44
4	5	(((((USUI or HIDEKI or IGARASHI or SAKAMOTO).in.) and plasma same irradiat\$3) and (resin or polymer)) and (resin or polymer) same (over or cover\$3) same (die or chip or IC or element or circuit)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 13:45
5	11	438/106.ccls. and irradiat\$3 same plasma	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 13:55
-	522	438/597.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 13:42
-	37	438/597.ccls. and resin and plasma	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/22 15:16
-	42	438/124.ccls. and plasma	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/22 15:16
-	0	(438/597.ccls. and resin and plasma) and (438/124.ccls. and plasma) and ((irradiating or plasma) same resin)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/22 15:17
-	43	(438/597.ccls. and resin and plasma) or (438/124.ccls. and plasma) and ((irradiating or plasma) same resin)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/22 15:17
-	6	((438/597.ccls. and resin and plasma) or (438/124.ccls. and plasma) and ((irradiating or plasma) same resin)) and rough\$5	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/22 15:36
-	4	6,596,559	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/22 16:02
-	2548	438/106.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/22 16:05
-	41	438/106.ccls. and rough\$6 and plasma	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 13:55
-	0	6713858.URPN.	USPAT	2004/06/22 17:21

-	27	("3013926"   "4211824"   "4251409"   "4388132"   "4680228"   "5002808"   "5098618"   "5104944"   "5121190"   "5147084"   "5391650"   "5583747"   "5683757"   "5745984"   "5948484"   "6074895"   "6248614"   "6259155"   "6284050"   "6288900"   "6294741"   "6353420"   "6512295"   "6548909"   "6596559"   "6624507"   "6642613").PN.	USPAT	2004/06/22 17:23
-	481	438/\$5.ccls. and resin and (openings same pads)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 10:26
-	407	(438/\$5.ccls. and resin and (openings same pads)) and (chip or die) and (top or over or covering)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 10:26
-	104	((438/\$5.ccls. and resin and (openings same pads)) and (chip or die) and (top or over or covering)) and exposing same pads	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 10:27
-	32	((((438/\$5.ccls. and resin and (openings same pads)) and (chip or die) and (top or over or covering)) and exposing same pads) and encapsulating	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 10:27
-	3	(((((438/\$5.ccls. and resin and (openings same pads)) and (chip or die) and (top or over or covering)) and exposing same pads) and encapsulating) and (O2 or oxygen)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 10:28
-	2	6689641.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 12:26
-	13	(US-6074895-\$ or US-5002808-\$ or US-6713858-\$ or US-6248655-\$ or US-6600224-\$ or US-6596559-\$ or US-6602803-\$ or US-5766979-\$ or US-6512295-\$ or US-4388132-\$ or US-6479409-\$ or US-6689641-\$).did. or (US-20020130397-\$).did.	USPAT; US-PGPUB	2004/06/23 12:51
-	1	((US-6074895-\$ or US-5002808-\$ or US-6713858-\$ or US-6248655-\$ or US-6600224-\$ or US-6596559-\$ or US-6602803-\$ or US-5766979-\$ or US-6512295-\$ or US-4388132-\$ or US-6479409-\$ or US-6689641-\$).did. or (US-20020130397-\$).did.) and (inert or helium or argon or neon).clm.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 12:52
-	4	((US-6074895-\$ or US-5002808-\$ or US-6713858-\$ or US-6248655-\$ or US-6600224-\$ or US-6596559-\$ or US-6602803-\$ or US-5766979-\$ or US-6512295-\$ or US-4388132-\$ or US-6479409-\$ or US-6689641-\$).did. or (US-20020130397-\$).did.) and (inert or helium or argon or neon)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 12:53
-	0	JP2001-230527	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/23 16:40
-	7704	(438/15 or 438/106 or 438/118 or 438/108 or 438/121 or 438/778 or 438/780 or 438/790 or 438/780).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 11:52

-	5	((438/15 or 438/106 or 438/118 or 438/108 or 438/121 or 438/778 or 438/780 or 438/790 or 438/780).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 11:59
-	1210	) and (plasma adj irradiating) ((438/15 or 438/106 or 438/118 or 438/108 or 438/121 or 438/778 or 438/780 or 438/790 or 438/780).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 12:00
-	61	) and voltage (((438/15 or 438/106 or 438/118 or 438/108 or 438/121 or 438/778 or 438/780 or 438/790 or 438/780).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 12:00
-	30	) and voltage) and (voltage same rf same plasma) ((((438/15 or 438/106 or 438/118 or 438/108 or 438/121 or 438/778 or 438/780 or 438/790 or 438/780).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 12:01
-	28	) and voltage) and (voltage same rf same plasma)) and (resin or polymer) ((((((438/15 or 438/106 or 438/118 or 438/108 or 438/121 or 438/778 or 438/780 or 438/790 or 438/780).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 12:11
-	0	) and voltage) and (voltage same rf same plasma)) and (resin or polymer)) and conductive ((438/15 or 438/106 or 438/118 or 438/108 or 438/121 or 438/778 or 438/780 or 438/790 or 438/780).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 12:11
-	1	) and (backside adj conductive adj layer) (((438/15 or 438/106 or 438/118 or 438/108 or 438/121 or 438/778 or 438/780 or 438/790 or 438/780).ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 12:14
-	11	) or 438/597) and (backside adj conductive adj layer) 438/\$5 and (backside adj conductive adj layer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 12:24
-	80	conductive same polymer same substrate same bias	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 12:25
-	23	(conductive same polymer same substrate same bias) and conductive and plasma	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 12:37
-	15	("4333793"   "5001083"   "5087857"   "5362358"   "5368685"   "5439849"   "5441595"   "5468341"   "5614060"   "5683517"   "5683538"   "5877032"   "5895740"   "5942446"   "6251791").PN.	USPAT	2004/07/02 12:34
-	0	(irradiat\$3 adj plasma) same (voltage same conductive same backside)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 12:38
-	0	(irradiat\$3 adj plasma) and (voltage same conductive same backside)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 12:39

-	0	(irradiat\$3 same plasma) and (voltage same conductive same backside)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 12:39
-	0	(irradiat\$3 same plasma) and (bias same conductive same backside)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 12:39
-	8	(irradiat\$3 same plasma) and bias and (conductive same backside)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 13:02
-	7	((irradiat\$3 same plasma) and bias and (conductive same backside)) and voltage	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 12:39
-	31	(irradiat\$3 same plasma) and ((metal or conductive) same backside) and (resin or polymer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 12:49
-	53	(expos\$3 same plasma same (polymer or resin)) and ((metal or conductive) same backside)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 12:49
-	4	((irradiat\$3 or expos\$3) same plasma) and ((connection same backside) same (cathode or anode))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/02 13:03